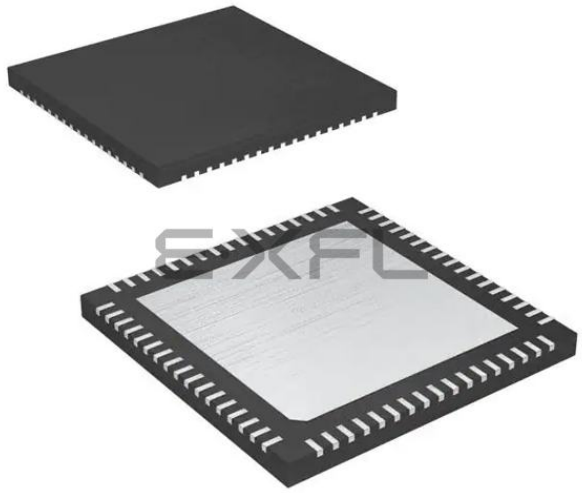
Analog Devices Inc./Maxim Integrated - 73S1209F-68IMR/F Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	80515
Core Size	8-Bit
Speed	24MHz
Connectivity	I²C, SmartCard, UART/USART
Peripherals	LED, POR, WDT
Number of I/O	9
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	68-VFQFN Exposed Pad
Supplier Device Package	68-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/73s1209f-68imr-f

Tables

Table 3: Flash Special Function Registers

Register	SFR Address	R/W	Description
ERASE	0x94	W	This register is used to initiate either the Flash Mass Erase cycle or the Flash Page Erase cycle. Specific patterns are expected for ERASE in order to initiate the appropriate Erase cycle (default = 0x00). 0x55 – Initiate Flash Page Erase cycle. Must be proceeded by a write to PGADDR @ SFR 0xB7. 0xAA – Initiate Flash Mass Erase cycle. Must be proceeded by a write to FLSH_MEEN @ SFR 0xB2 and the debug port must be enabled. Any other pattern written to ERASE will have no effect.
PGADDR	0xB7	R/W	Flash Page Erase Address register containing the flash memory page address (page 0 through 127) that will be erased during the Page Erase cycle (default = 0x00). Note: the page address is shifted left by one bit (see detailed description above). Must be re-written for each new Page Erase cycle.
FLSHCTL	0xB2	R/W	Bit 0 (FLSH_PWE): Program Write Enable: 0 – MOVX commands refer to XRAM Space, normal operation (default). 1 – MOVX @DPTR,A moves A to Program Space (Flash) @ DPTR. This bit is automatically reset after each byte written to flash. Writes to this bit are inhibited when interrupts are enabled.
		W	Bit 1 (FLSH_MEEN): Mass Erase Enable: 0 – Mass Erase disabled (default). 1 – Mass Erase enabled. Must be re-written for each new Mass Erase cycle.
		R/W	Bit 6 (SECURE): Enables security provisions that prevent external reading of flash memory and CE program RAM. This bit is reset on chip reset and may only be set. Attempts to write zero are ignored.

1.7.3 Interrupts

The 80515 core provides 10 interrupt sources with four priority levels. Each source has its own request flag(s) located in a special function register (TCON, IRCON, and SCON). Each interrupt requested by the corresponding flag can be individually enabled or disabled by the enable bits in SFRs IEN0, IEN1, and IEN2. Some of the 10 sources are multiplexed in order to expand the number of interrupt sources. These will be described in more detail in the respective sections.

External interrupts are the interrupts external to the 80515 core, i.e. signals that originate in other parts of the 73S1209F, for example the USR I/O, smart card interface, analog comparators, etc. The external interrupt configuration is shown in Figure 8.

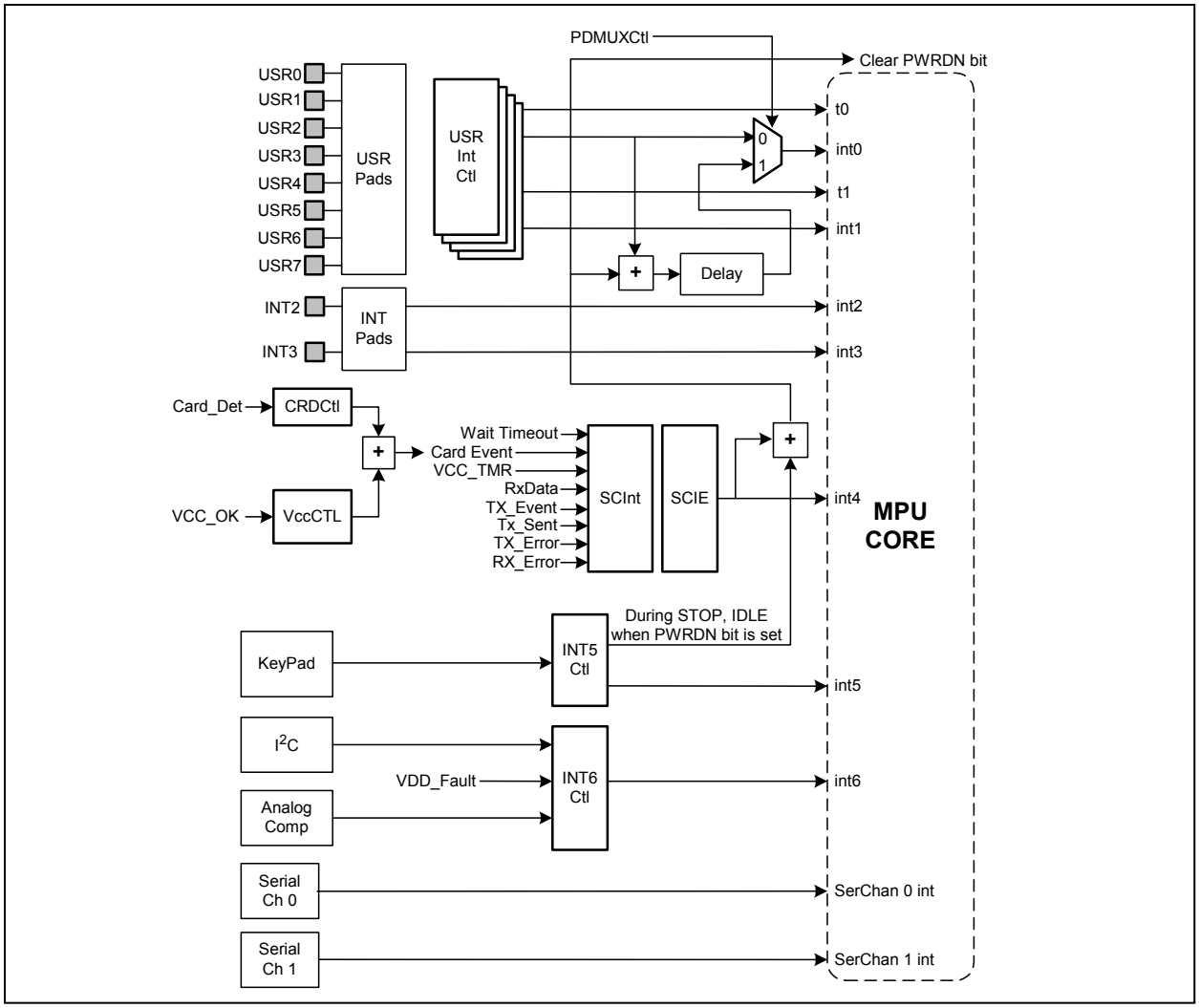


Figure 8: External Interrupt Configuration

Timer/Counter Control Register (TCON): 0x88 ← 0x00

Table 22: The TCON Register

MSB							LSB
TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0

Bit	Symbol	Function
TCON.7	TF1	Timer 1 overflow flag.
TCON.6	TR1	Not used for interrupt control.
TCON.5	TF0	Timer 0 overflow flag.
TCON.4	TR0	Not used for interrupt control.
TCON.3	IE1	Interrupt 1 edge flag is set by hardware when the falling edge on external interrupt int1 is observed. Cleared when an interrupt is processed.
TCON.2	IT1	Interrupt 1 type control bit. 1 selects falling edge and 0 selects low level for input pin to cause an interrupt.
TCON.1	IE0	Interrupt 0 edge flag is set by hardware when the falling edge on external interrupt int0 is observed. Cleared when an interrupt is processed.
TCON.0	IT0	Interrupt 0 type control bit. 1 selects falling edge and 0 sets low level for input pin to cause interrupt.

Timer/Interrupt 2 Control Register (T2CON): 0xC8 ← 0x00

Table 23: The T2CON Register

MSB							LSB
–	I3FR	I2FR	–	–	–	–	–

Bit	Symbol	Function
T2CON.7	–	
T2CON.6	I3FR	External interrupt 3 failing/rising edge flag. I3FR = 0 external interrupt 3 negative transition active. I3FR = 1 external interrupt 3 positive transition active.
T2CON.5	I2FR	External interrupt 3 failing/rising edge flag. I2FR = 0 external interrupt 3 negative transition active. I2FR = 1 external interrupt 3 positive transition active.
T2CON.4	–	
T2CON.3	–	
T2CON.2	–	
T2CON.1	–	
T2CON.0	–	

Miscellaneous Control Register 0 (MISCtl0): 0xFFF1 ← 0x00

Transmit and receive (TX and RX) pin selection and loop back test configuration are set up via this register.

Table 37: The MISCtl0 Register

MSB							LSB
PWRDN	–	–	–	–	–	SLPBK	SSEL

Bit	Symbol	Function
MISCtl0.7	PWRDN	This bit places the 73S1209F into a power down state.
MISCtl0.6	–	
MISCtl0.5	–	
MISCtl0.4	–	
MISCtl0.3	–	
MISCtl0.2	–	
MISCtl0.1	SLPBK	1 = UART loop back testing mode. The pins TXD and RXD are to be connected together externally (with SLPBK =1) and therefore: SLPBK SSEL Mode 0 0 normal using Serial_0 0 1 normal using Serial_1 1 0 Serial_0 TX feeds Serial_1 RX 1 1 Serial_1 TX feeds Serial_0 RX
MISCtl0.0	SSEL	Selects either Serial_1 if set =1 or Serial_0 if set = 0 to be connected to RXD and TXD pins.

1.7.4.1 Serial Interface 0

The Serial Interface 0 can operate in four modes:

- **Mode 0**

  Pin RX serves as $_{input}$ and output. TX outputs the shift clock. Eight bits are transmitted with the LSB first. The baud rate is fixed at 1/12 of the crystal frequency. Reception is initialized in Mode 0 by setting the flags in S0CON as follows: RI0 = 0 and REN0 = 1. In other modes, a start bit when REN0 = 1 starts receiving serial data.

- **Mode 1**

  Pin RX serves as input, and TX serves as serial output. No external shift clock is used, 10 bits are transmitted: a start bit (always 0), 8 data bits (LSB first), and a stop bit (always 1). On receive, a start bit synchronizes the transmission, 8 data bits are available by reading S0BUF, and stop bit sets the flag RB80 in the Special Function Register S0CON. In mode 1 either internal baud rate generator or timer 1 can be use to specify baud rate.

- **Mode 2**

  This mode is similar to Mode 1, with two differences. The baud rate is fixed at 1/32 or 1/64 of oscillator frequency and 11 bits are transmitted or received: a start bit (0), 8 data bits (LSB first), a programmable 9th bit, and a stop bit (1). The 9th bit can be used to control the parity of the serial interface: at transmission, bit TB80 in S0CON is output as the 9th bit, and at receive, the 9th bit affects RB80 in Special Function Register S0CON.

- **Mode 3**

  The only difference between Mode 2 and Mode 3 is that in Mode 3 either internal baud rate generator or timer 1 can be use to specify baud rate.

The S0BUF register is used to read/write data to/from the serial 0 interface.

Interrupt Priority 0 Register (IP0): 0xA9 ← 0x00

Table 46: The IP0 Register

MSB							LSB
–	WDTS	IP0.5	IP0.4	IP0.3	IP0.2	IP0.1	IP0.0

Bit	Symbol	Function
IP0.6	WDTS	Watchdog timer status flag. Set when the watchdog timer has expired. The internal reset will be generated, but this bit will not be cleared by the reset. This allows the user program to determine if the watchdog timer caused the reset to occur and respond accordingly. Can be read and cleared by software.

Note: The remaining bits in the IP0 register are not used for watchdog control.

Watchdog Timer Reload Register (WDTREL): 0x86 ← 0x00

Table 47: The WDTREL Register

MSB							LSB
WDPSEL	WDREL6	WDREL5	WDREL4	WDREL3	WDREL2	WDREL1	WDREL0

Bit	Symbol	Function
WDTREL.7	WDPSEL	Prescaler select bit. When set, the watchdog is clocked through an additional divide-by-16 prescaler.
WDTREL.6 to WDTREL.0	WDREL6-0	Seven bit reload value for the high-byte of the watchdog timer. This value is loaded to the WDT when a refresh is triggered by a consecutive setting of bits WDT and SWDT.

Keypad Column Register (KCOL): 0xD1 ← 0x1F

This register contains the value of the column of a key detected as valid by the hardware. In bypass mode, this register firmware writes directly this register to carry out manual scanning.

Table 65: The KCOL Register

MSB							LSB
–	–	–	COL.4	COL.3	COL.2	COL.1	COL.0

Bit	Symbol	Function
KCOL.7	–	
KCOL.6	–	
KCOL.5	–	
KCOL.4	COL.4	Drive lines bit mapped to corresponding with pins COL(4:0). When a key is detected, firmware reads this register to determine column. In bypass (S/W keyscan) mode, Firmware writes this register directly. 0x1E = COL(0) low, all others high. 0x0F = COL(4) low, all others high. 0x1F = COL(4:0) all high.
KCOL.3	COL.3	
KCOL.2	COL.2	
KCOL.1	COL.1	
KCOL.0	COL.0	

Keypad Row Register (KROW): 0xD2 ← 0x3F

This register contains the value of the row of a key detected as valid by the hardware. In bypass mode, this register firmware reads directly this register to carry out manual detection.

Table 66: The KROW Register

MSB							LSB
–	–	ROW.5	ROW.4	ROW.3	ROW.2	ROW.1	ROW.0

Bit	Symbol	Function
KROW.7	–	
KROW.6	–	
KROW.5	ROW.6	Sense lines bit mapped to correspond with pins ROW(5:0). When key detected, firmware reads this register to determine row. In bypass mode, firmware reads rows and has to determine if there was a key press or not. 0x3E = ROW(0) low, all others high. 0x1F = ROW(5) low, all others high. 0x3F = ROW(5:0) all high.
KROW.4	ROW.4	
KROW.3	ROW.3	
KROW.2	ROW.2	
KROW.1	ROW.1	
KROW.0	ROW.0	

Keypad Scan Time Register (KSIZE): 0xD5 ← 0x00

This register is not applicable when HWSCEN is not set. Unused row inputs should be connected to VDD.

Table 69: The KSIZE Register

MSB							LSB
–	–	ROWSIZ.2	ROWSIZ.1	ROWSIZ.0	COLSIZ.2	COLSIZ.1	COLSIZ.0

Bit	Symbol	Function
KSIZE.7	–	
KSIZE.6	–	
KSIZE.5	ROWSIZ.2	Defines the number of rows in the keypad. Maximum number is 6 given the number of row pins on the package. Allows for a reduced keypad size for scanning.
KSIZE.4	ROWSIZ.1	
KSIZE.3	ROWSIZ.0	
KSIZE.2	COLSIZ.2	Defines the number of columns in the keypad. Maximum number is 5 given the number of column pins on the package. Allows for a reduced keypad size for scanning.
KSIZE.1	COLSIZ.1	
KSIZE.0	COLSIZ.0	

Keypad Column LS Scan Order Register (KORDERL): 0xD6 ← 0x00

In registers KORDERL and KORDERH, Column Scan Order(14:0) is grouped into 5 sets of 3 bits each. Each set determines which column (COL(4:0) pin) to activate by loading the column number into the 3 bits. When in HW_Scan_Enable mode, the hardware will step through the sets from 1Col to 5Col (up to the number of columns in Colsize) and scan the column defined in the 3 bits. To scan in sequential order, set a counting pattern with 0 in set 0, and 1 in set 1,and 2 in set 2, and 3 in set 3, and 4 in set 4. The firmware should update this as part of the interrupt service routine so that the new scan order is loaded prior to the next key being pressed. For example, to scan COL(0) first, 1Col(2:0) should be loaded with 000'b. To scan COL(4) fifth, 5Col(2:0) should be loaded with 100'b.

Table 70: The KORDERL Register

MSB							LSB
3COL.1	3COL.0	2COL.2	2COL.1	2COL.0	1COL.2	1COL.1	1COL.0

Bit	Symbol	Function
KORDERL.7	3COL.1	Column to scan 3rd (lsb's).
KORDERL.6	3COL.0	
KORDERL.5	2COL.2	Column to scan 2nd.
KORDERL.4	2COL.1	
KORDERL.3	2COL.0	
KORDERL.2	1COL.2	Column to scan 1st.
KORDERL.1	1COL.1	
KORDERL.0	1COL.0	

Block Guard Time register (BGT). Other than the protocol checks described above, the firmware is responsible for all protocol checking and error recovery.

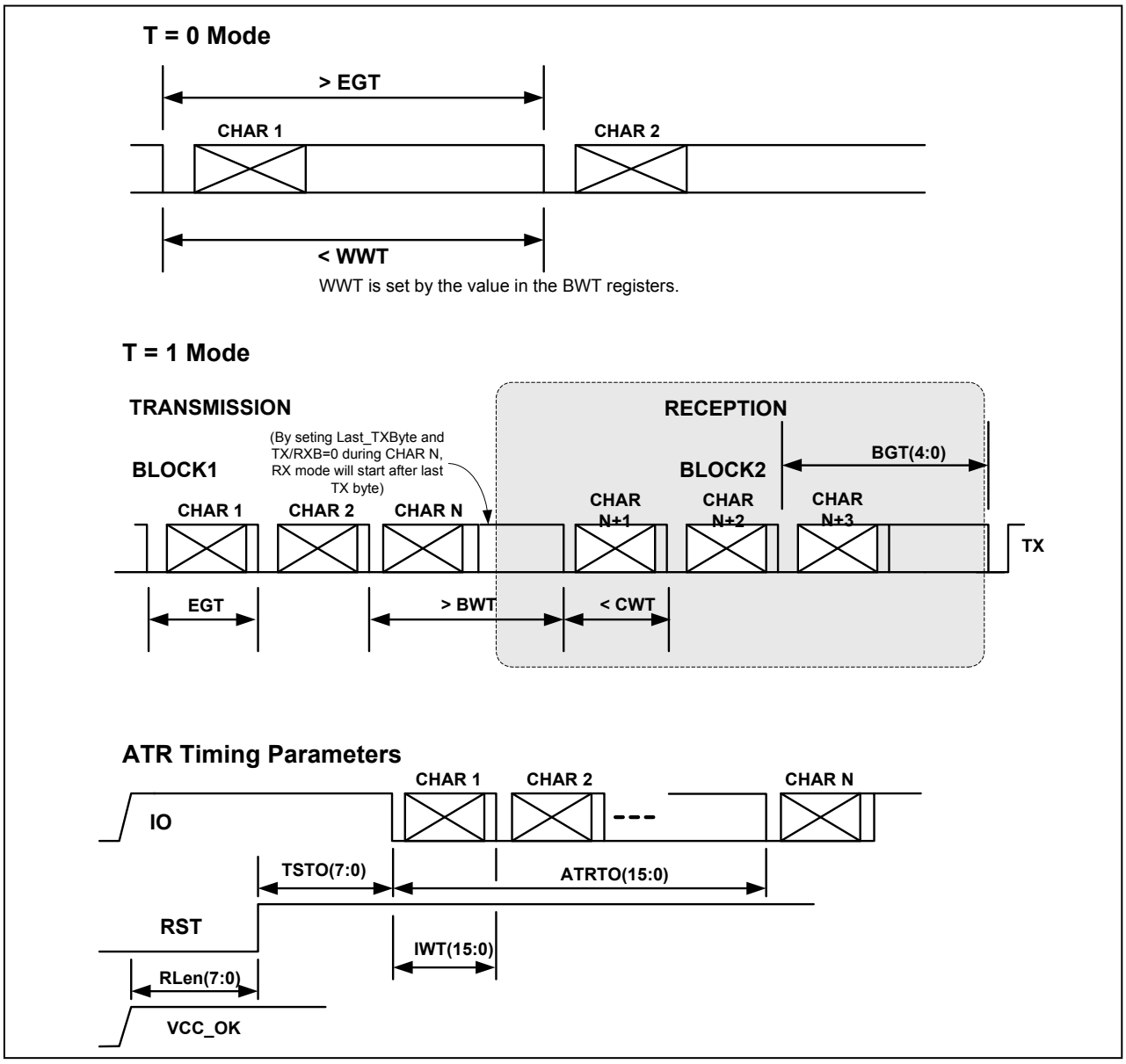


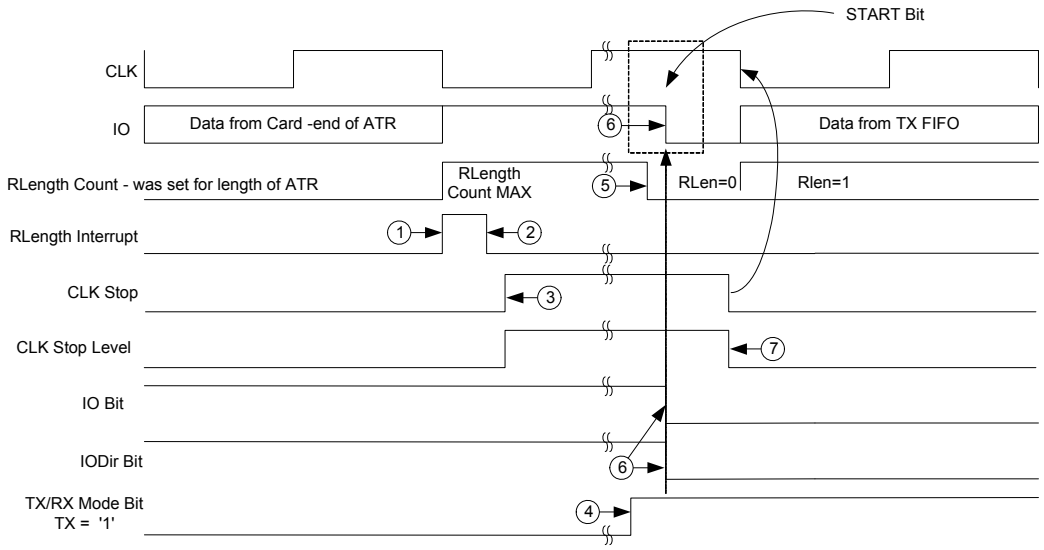
Figure 18: Guard, Block, Wait and ATR Time Definitions

1.7.13.4 Bypass Mode

It is possible to bypass the smart card UART in order for the firmware to support non-T=0/T=1 smart cards. This is called Bypass mode. In this mode the embedded firmware will communicate directly with the selected smart card and drive I/O during transmit and read I/O during receive in order to communicate with the smart card. In this mode, ATR processing is under firmware control. The firmware must sequence the interface signals as required. Firmware must perform TS processing, parity checking, break generation and CRC/LRC calculation (if required).

1.7.13.5 Synchronous Operation Mode

The 73S1209F supports synchronous operation. When sync mode is selected for either interface, the CLK signal is generated by the ETU counter. The values in FDReg, SCCLK, and SCECLK must be set to obtain the desired sync CLK rate. There is only one ETU counter and therefore, in sync mode, the interface must

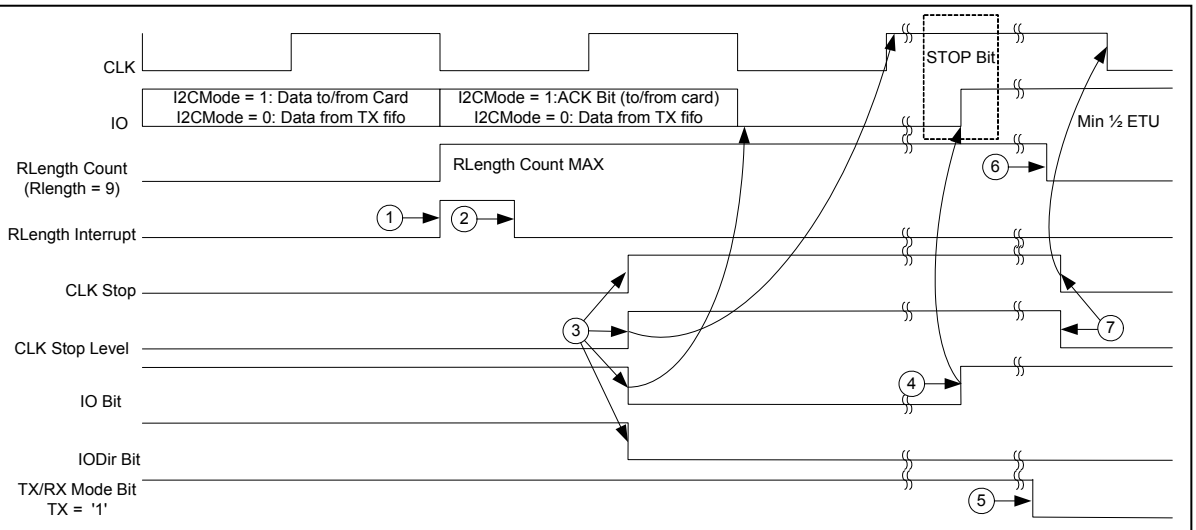


1. Interrupt generated when Rlength counter is MAX.
2. Read and clear Interrupt.
3. Set CLK Stop and CLK Stop level high in Interrupt routine.
4. Set TX/RX Bit to TX mode.
5. Reload Rlength Counter.
6. Set IO Bit low and IODir = Output. Since Rlen=(MAX or 0) and TX/RX =1, IO pin is controlled by IO bit.
7. Clear CLK Stop and CLK Stop level.

Note: Data in TX fifo should not be Empty here.

Synchronous Clock Start/Stop Mode style Start bit procedure. This procedure should be used to generate the start bit insertion in Synchronous mode for Synchronous Clock Start/Stop Mode protocol.

Figure 21: Creation of Synchronous Clock Start/Stop Mode Start Bit in Sync Mode



1. Interrupt generated when Rlength counter is MAX.
2. Read and clear Interrupt.
3. Set CLK Stop and CLK Stop level high, set IO Bit low and IODir = Output.
4. Set IO Bit High and IODir = Output.
5. Set TX/RX Bit to RX mode.
6. Reload Rlength Counter.
7. Clear CLK Stop and CLK Stop level.

Synchronous Clock Start/Stop Mode Stop bit procedure. This procedure should be used to generate the Stop bit in Synchronous Mode.

Figure 22: Creation of Synchronous Clock Start/Stop Mode Stop Bit in Sync Mode

1.7.13.6 Smart Card SFRs

Smart Card Select Register (SCSel): 0xFE00 ← 0x00

The smart card select register is used to determine which smart card interface is using the ISO UART. The internal Smart Card has integrated 7816-3 compliant sequencer circuitry to drive an external smart card interface. The external smart card interface relies on 73S8010x parts to generate the ISO 7816-3 compatible signals and sequences. Multiple 73S8010x devices can be connected to the external smart card interface.

Table 73: The SCSel Register

MSB							LSB
–	–	–	–	SELSC.1	SELSC.0	BYPASS	–

Bit	Symbol	Function
SCSel.7	–	
SCSel.6	–	
SCSel.5	–	
SCSel.4	–	
SCSel.3	SELSC.1	Select Smart Card Interface – These bits select the interface that is using the IS0 UART. These bits do not activate the interface. Activation is performed by the VccCtl register. 00 = No smart card interface selected. 01 = External Smart Card Interface selected (using SCLK, SIO). 1X = Internal Smart Card Interface selected.
SCSel.2	SELSC.0	
SCSel.1	BYPASS	1 = Enabled, 0 = Disabled. When enabled, ISO UART is bypassed and the I/O line is controlled via the SCCtl and SCECtl registers.
SCSel.0	–	

Smart Card Interrupt Enable Register (SCIE): 0xFE02 ← 0x00

When set to a 1, the respective condition can cause a smart card interrupt. When set to a 0, the respective condition cannot cause an interrupt. When disabled, the respective bit in the Smart Card Interrupt register can still be set, but it will not interrupt the MPU.

Table 75: The SCIE Register

MSB LSB

WTOIEN	CDEVEN	VTMREN	RXDAEN	TXEVEN	TXSNTEN	TXEREN	RXEREN

Bit	Symbol	Function
SCIE.7	WTOIEN	Wait Timeout Interrupt Enable – Enable for ATR or Wait Timeout Interrupt. In sync mode, function is RLIEN (RLen = max.) interrupt enable.
SCIE.6	CDEVEN	Card Event Interrupt Enable.
SCIE.5	VTMREN	VCC Timer Interrupt Enable.
SCIE.4	RXDAEN	Rx Data Available Interrupt Enable.
SCIE.3	TXEVEN	TX Event Interrupt Enable.
SCIE.2	TXSNTEN	TX Sent Interrupt Enable.
SCIE.1	TXEREN	TX Error Interrupt Enable.
SCIE.0	RXEREN	RX Error Interrupt Enable.

Card Status/Control Register (CRDCtl): 0xFE05 ← 0x00

This register is used to configure the card detect pin (DETCARD) and monitor card detect status. This register be written to properly configure Debounce, Detect_Polarity (= 0 or = 1), and the pull-up/down enable before setting CDETEN. The card detect logic is functional even without smart card logic clock. When the PWRDN bit is set = 1, no debounce is provided but card presence is operable.

Table 78: The CRDCtl Register

MSB							LSB
DEBOUN	CDETEN	–	–	DETPOL	PUENB	PDEN	CARDIN

Bit	Symbol	Function
CRDCtl.7	DEBOUN	Debounce – When set = 1, this will enable hardware de-bounce of the card detect pin. The de-bounce function shall wait for 64ms of stable card detect assertion before setting the CARDIN bit. This counter/timer uses the keypad clock as a source of 1kHz signal. De-assertion of the CARDIN bit is immediate upon de-assertion of the card detect pin(s).
CRDCtl.6	CDETEN	Card Detect Enable – When set = 1, activates card detection input. Default upon power-on reset is 0.
CRDCtl.5	–	
CRDCtl.4	–	
CRDCtl.3	DETPOL	Detect Polarity – When set = 1, the DETCARD pin shall interpret a logic 1 as card present.
CRDCtl.2	PUENB	Enable pull-up current on DETCARD pin (active low).
CRDCtl.1	PDEN	Enable pull-down current on DETCARD pin.
CRDCtl.0	CARDIN	Card Inserted – (Read only). 1 = card inserted, 0 = card not inserted. A change in the value of this bit is a “card event.” A read of this bit indicates whether smart card is inserted or not inserted in conjunction with the DETPOL setting.

TX Control/Status Register (STXCtl): 0xFE06 ← 0x00

This register is used to control transmission of data to the smart card. Some control and some status bits are in this register.

Table 79: The STXCtl Register

MSB							LSB
SYCKST	–	TXFULL	TXEMTY	TXUNDR	LASTTX	TX/RXB	BREAKD

Bit	Symbol	Function
STXCtl.7	I2CMODE	I2C Mode – When in sync mode and this bit is set, and when the RLen count value = max or 0, the source of the smart card data for IO pin (or SIO pin) will be connected to the IO bit in SCCtl (or SCECtl) register rather than the TX FIFO. See the description for the Protocol Mode Register for more detail.
STXCtl.6	–	
STXCtl.5	TXFULL	TX FIFO is full. Additional writes may corrupt the contents of the FIFO. This bit it will remain set as long as the TX FIFO is full. Generates TX_Event interrupt upon going full.
STXCtl.4	TXEMTY	1 = TX FIFO is empty, 0 = TX FIFO is not empty. If there is data in the TX FIFO, the circuit will transmit it to the smart card if in transmit mode. In T=1 mode, if the LASTTX bit is set and the hardware is configured to transmit the CRC/LRC, the TXEMTY will not be set until the CRC/LRC is transmitted. In T=0, if the LASTTX bit is set, TXEMTY will be set after the last word has been successfully transmitted to the smart card. Generates TXEVNT interrupt upon going empty.
STXCtl.3	TXUNDR	TX Underrrun – (Read only) Asserted when a transmit under-run condition has occurred. An under-run condition is defined as an empty TX FIFO when the last data word has been successfully transmitted to the smart card and the LASTTX bit was not set. No special processing is performed by the hardware if this condition occurs. Cleared when read by firmware. This bit generates TXERR interrupt.
STXCtl.2	LASTTX	Last TX Byte – Set by firmware (in both T=0 and T=1) when the last byte in the current message has been written into the transmit FIFO. In T=1 mode, the CRC/LRC will be appended to the message. Should be set after the last byte has been written into the transmit FIFO. Should be cleared by firmware before writing first byte of next message into the transmit FIFO. Used in T=0 to determine when to set TXEMTY.
STXCtl.1	TX/RXB	1 = Transmit mode, 0 = Receive mode. Configures the hardware to be receiving from or transmitting to the smart card. Determines which counters should be enabled. This bit should be set to receive mode prior to switching to another interface. Setting and resetting this bit shall initialize the CRC logic. If LASTTX is set, this bit can be reset to RX mode and UART logic will automatically change mode to RX when TX operation is completed (TX_Empty =1).
STXCtl.0	BREAKD	Break Detected – (Read only) 1 = A break has been detected on the I/O line indicating that the smart card detected a parity error. Cleared when read. This bit generates TXERR interrupt.

C4/C8 Data Direction Register (SCDIR): 0xFE0C ← 0x00

This register determines the direction of the internal interface C4/C8 lines. After reset, all signals are tri-stated.

Table 85: The SCDIR Register

MSB LSB

–	–	–	–	C8D	C4D	–	–

Bit	Symbol	Function
SCDIR.7	–	
SCDIR.6	–	
SCDIR.5	–	
SCDIR.4	–	
SCDIR.3	C8D	1 = input, 0 = output. Smart Card C8 direction.
SCDIR.2	C4D	1 = input, 0 = output. Smart Card C4 direction.
SCDIR.1	–	
SCDIR.0	–	

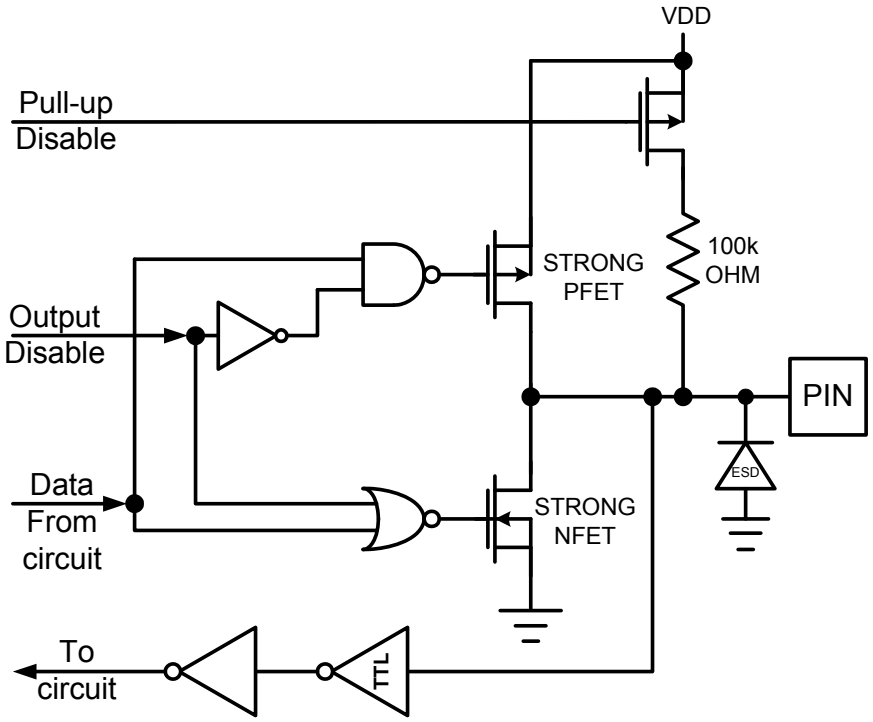


Figure 32: Keypad Row Circuit

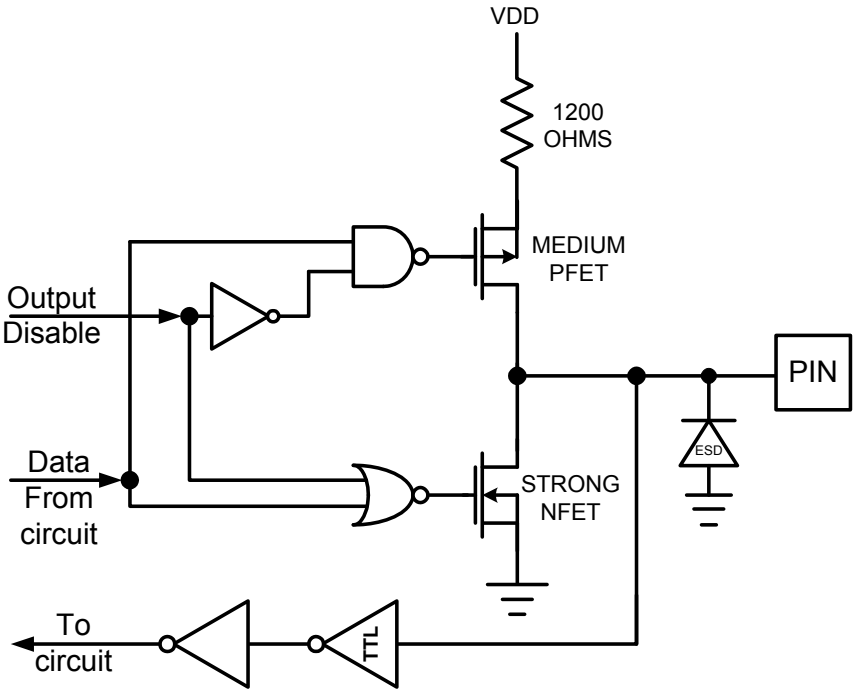


Figure 33: Keypad Column Circuit

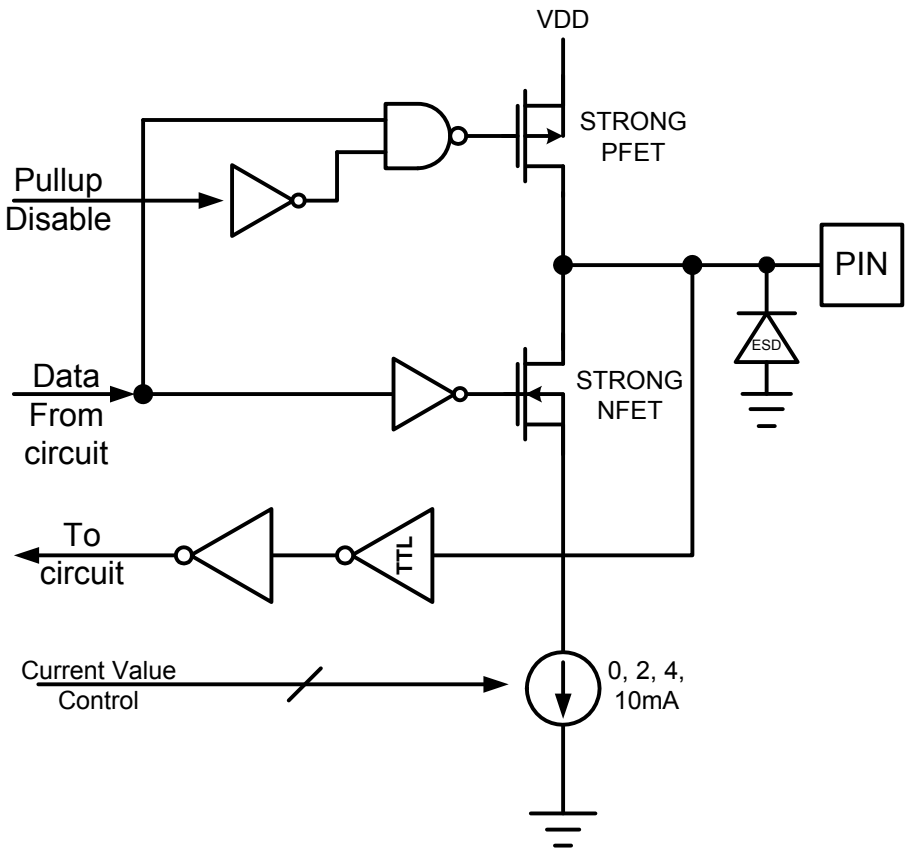


Figure 34: LED Circuit

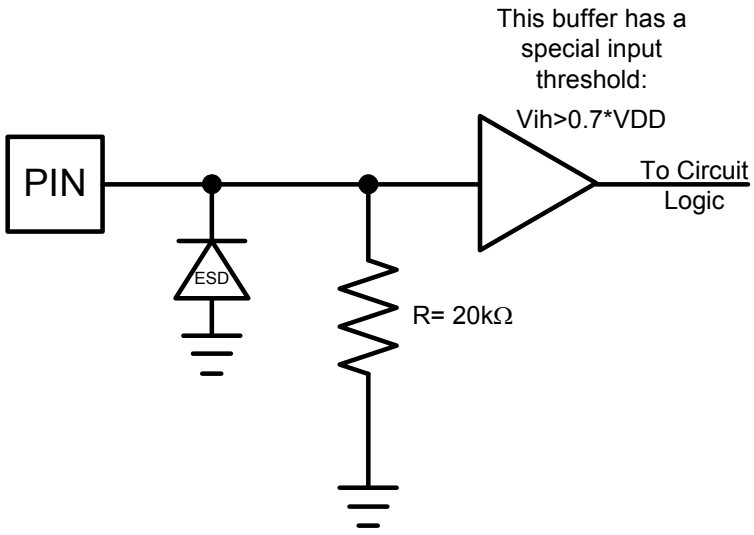


Figure 35: Test and Security Pin Circuit

4.1 Package Pin Designation (68-pin QFN)

CAUTION: Use handling procedures necessary for a static sensitive component

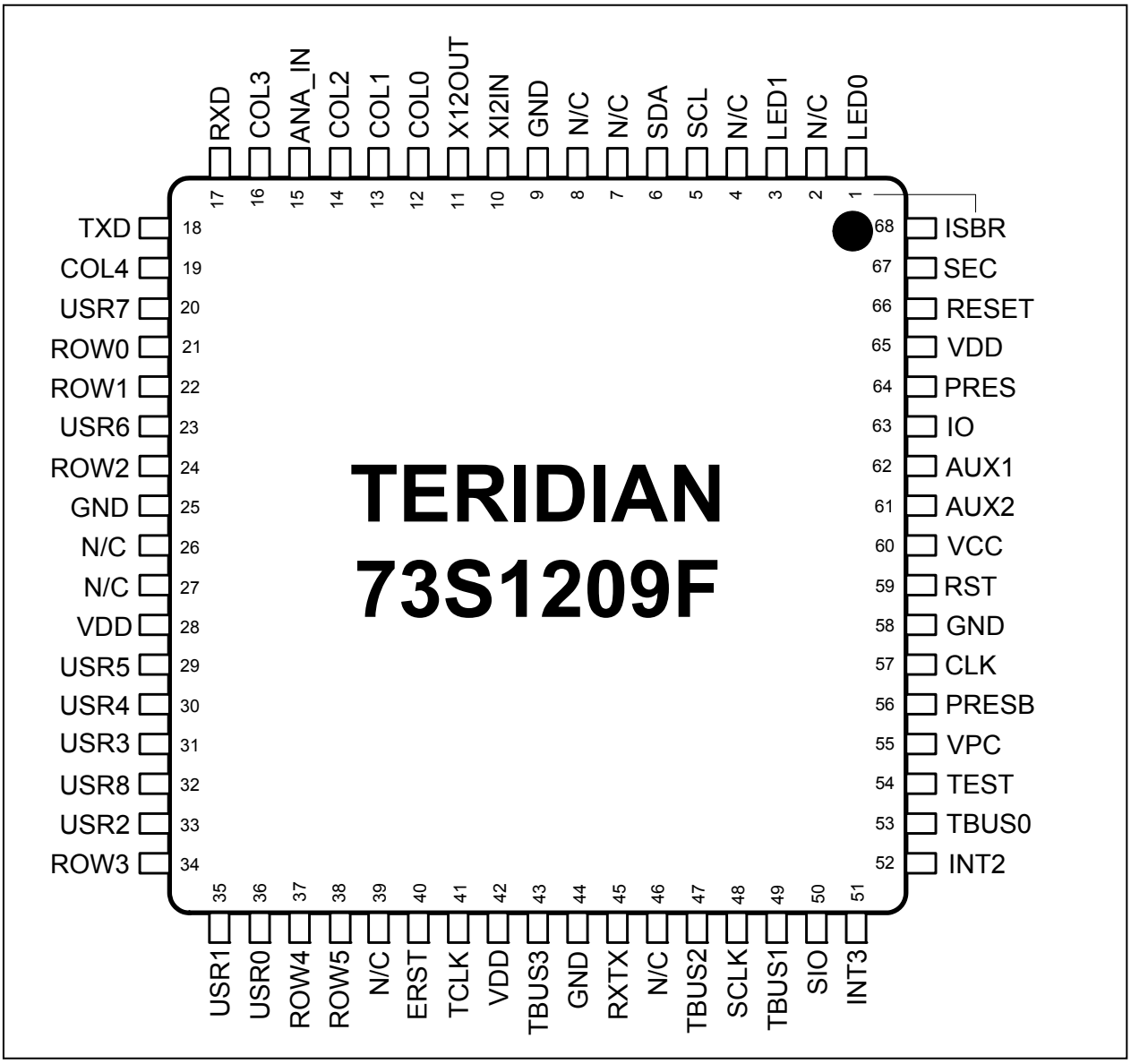


Figure 41: 73S1209F Pinout

44-Pin QFN PACKAGE OUTLINE

Notes: 5.1mm x 5.1mm exposed pad area must remain UNCONNECTED (clear of PCB traces or vias). Controlling dimensions are in mm.

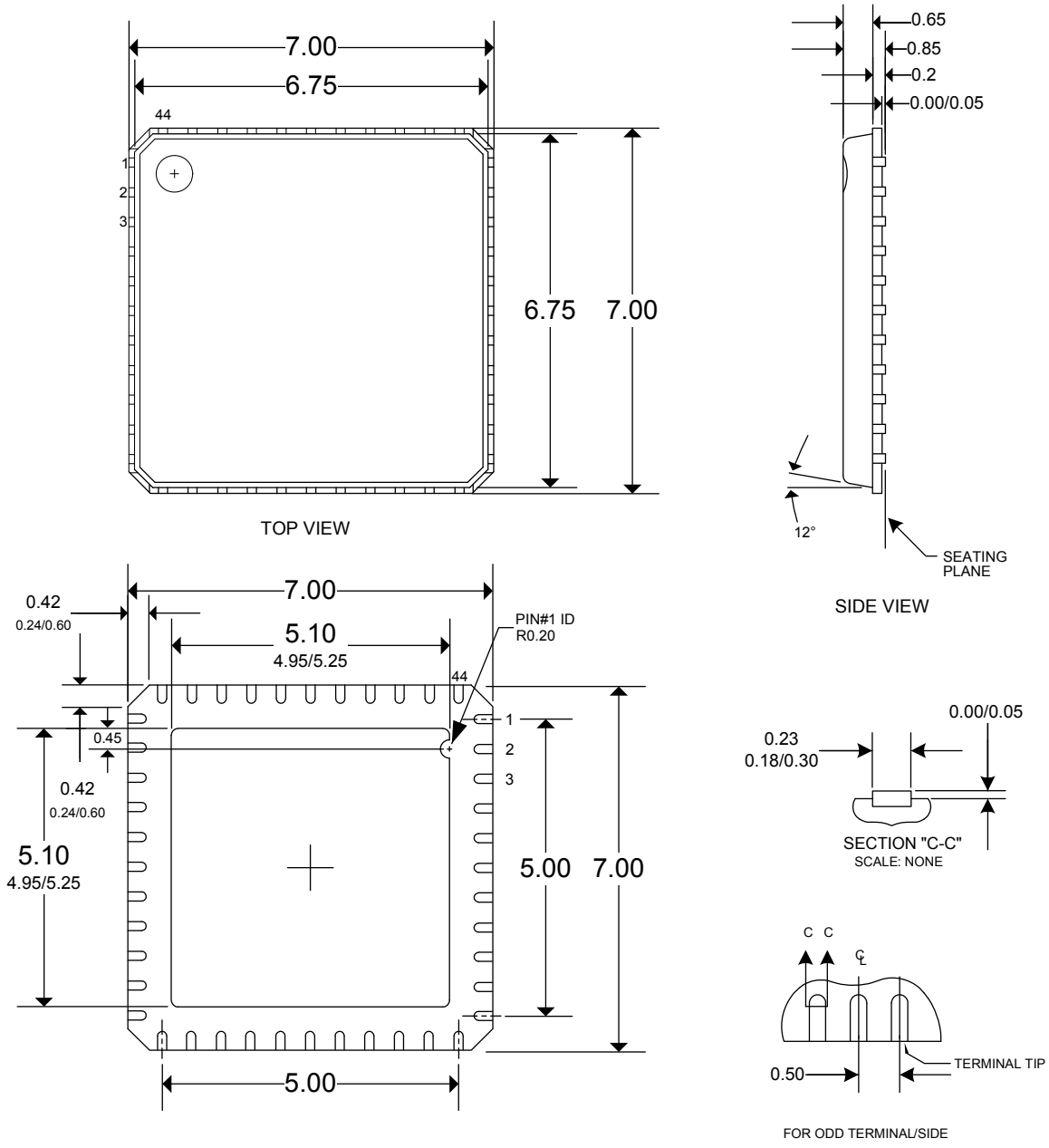


Figure 44: 73S1209F 44 QFN Pinout

5 Ordering Information

Table 110 lists the order numbers and packaging marks used to identify 73S1209F products.

Table 110: Order Numbers and Packaging Marks

Part Description	Order Number	Packaging Mark
73S1209F 68-Pin QFN Lead Free	73S1209F-68IM/F	73S1209F68IM
73S1209F 68-Pin QFN Lead Free, Tape and Reel	73S1209F-68IMR/F	73S1209F68IM
73S1209F 44-Pin QFN Lead Free	73S1209F-44IM/F	73S1209F44IM
73S1209F 44-Pin QFN Lead Free, Tape and Reel	73S1209F-44IMR/F	73S1209F44IM

6 Related Documentation

The following 73S1209F documents are available from Teridian Semiconductor Corporation:

73S1209F Data Sheet (this document)
73S1209F Development Board Quick Start Guide
73S1209F Software Development Kit Quick Start Guide
73S1209F Evaluation Board User's Guide
73S12xxF Software User's Guide
73S12xxF Synchronous Card Design Application Note

7 Contact Information

For more information about Teridian Semiconductor products or to check the availability of the 73S1209F, contact us at:

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